

# STGW30NC120HD

N-channel 1200V - 30A - TO-247 very fast PowerMESH™ IGBT

#### **Features**

Туре	V <sub>CES</sub>	V <sub>CE(sat)</sub> @25°C	I <sub>C</sub> @100°C
STGW30NC120HD	1200V	< 2.75V	30A

- Low on-losses
- Low on-voltage drop (V<sub>cesat</sub>)
- High current capability
- High input impedance (voltage driven)
- Low gate charge
- Ideal for soft switching application



#### **Application**

■ Induction heating

#### **Description**

Using the latest high voltage technology based on its patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, with outstanding performances. The suffix "H" identifies a family optimized for high frequency application in order to achieve very high switching performances (reduced tfall) maintaining a low voltage drop.

Figure 1. Internal schematic diagram

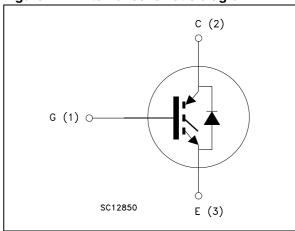


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW30NC120HD	GW30NC120HD	TO-247	Tube

October 2007 Rev 9 1/13

Contents STGW30NC120HD

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STGW30NC120HD Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GS</sub> = 0)	1200	٧
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at 25°C	60	Α
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at 100°C	30	Α
I <sub>CL</sub> <sup>(2)</sup>	Collector current (pulsed)	135	Α
V <sub>GE</sub>	Gate-emitter voltage	±25	٧
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	220	W
I <sub>f</sub>	Diode RMS forward current at T <sub>C</sub> = 25°C 30		Α
T <sub>j</sub>	Operating junction temperature	-55 to 150	°C

<sup>1.</sup> Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T}C, \ I_{C})}$$

2. Vclamp=80% of BVces, Tj=150°C,  $R_G$ =10 $\Omega$ ,  $V_{GE}$ =15V

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	0.57	°C/W
Rthj-amb	Thermal resistance junction-ambient (diode)	1.6	°C/W
Rthj-amb	Thermal resistance junction-ambient (IGBT)	30	°C/W

Electrical characteristics STGW30NC120HD

# 2 Electrical characteristics

( $T_{CASE}$ =25°C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>BR(CES)</sub>	Collector-emitter breakdown voltage	$I_C = 1$ mA, $V_{GE} = 0$	1200			٧
V <sub>CE(SAT)</sub>	Collector-emitter saturation voltage $V_{GE}$ = 15V, $I_{C}$ = 20A, Tj= 25°C $V_{GE}$ = 15V, $I_{C}$ = 20A, Tj=125°C			2.2 2.0	2.75	V V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	V
I <sub>CES</sub>	Collector-emitter leakage current (V <sub>GE</sub> = 0)	V <sub>CE</sub> =Max rating,Tc=25°C V <sub>CE</sub> =Max rating, Tc=125°C			500 10	μA mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> =± 20V, V <sub>CE</sub> = 0			± 100	nA
9 <sub>fs</sub>	Forward transconductance	$V_{CE} = 25V_{,} I_{C} = 20A$		14		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25V, f = 1 MHz, V <sub>GE</sub> =0		2510 175 30		pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	V <sub>CE</sub> = 960V, I <sub>C</sub> = 20A,V <sub>GE</sub> =15V		110 16 49		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15V, $T_{J}$ =25°C (see Figure 17)		29 11 1820		ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15V, $T_{J}$ = 125°C (see Figure 17)		27 14 1580		ns ns A/µs
$t_{r}(V_{off})$ $t_{d}(_{off})$ $t_{f}$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ $V_{GE}$ = 15V, $T_{J}$ = 25°C (see Figure 17)		90 275 312		ns ns ns
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ $V_{GE}$ = 15V, $T_{J}$ = 125°C (see Figure 17)		150 336 592		ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon <sup>(1)</sup> $E_{off}^{(2)}$ $E_{ts}$	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15V, $T_{j}$ = 25°C (see Figure 17)		1660 4438 6098		μJ μJ μJ
Eon <sup>(1)</sup> $E_{off}^{(2)}$ $E_{ts}$	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 960V, I_{C} = 20A$ $R_{G} = 10\Omega, V_{GE} = 15V,$ $T_{J} = 125^{\circ}C$ (see Figure 17)		3015 6900 9915		μJ μJ μJ

Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>f</sub>	Forward on-voltage	If = 20A, Tj = 25°C If = 20A, Tj = 125°C		1.9 1.7	2.5	V V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	If = 20A, $V_R$ = 27V, $T_j$ = 125°C, di/dt = 100A/ $\mu$ s (see Figure 20)		152 722 9		ns nC A

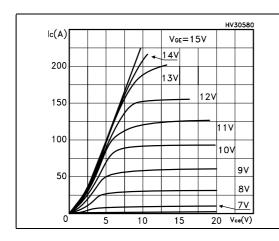
<sup>2.</sup> Turn-off losses include also the tail of the collector current

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### 2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



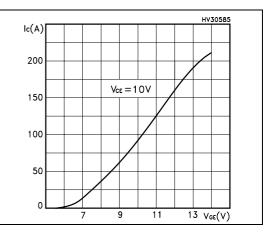
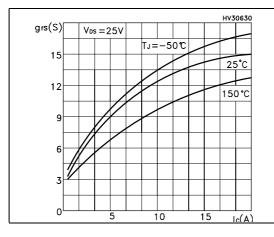


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs. temperature



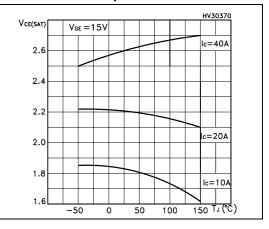
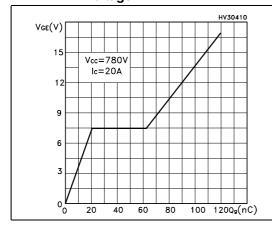


Figure 6. Gate charge vs. gate-source voltage

Figure 7. Capacitance variations



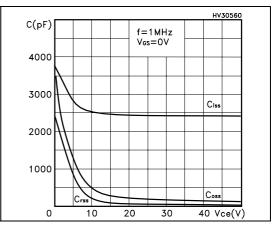


Figure 8. Normalized gate threshold voltage vs. temperature

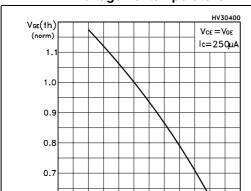


Figure 9. Collector-emitter on voltage vs. collector current

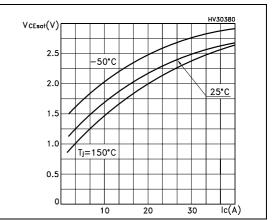


Figure 10. Normalized breakdown voltage vs. temperature

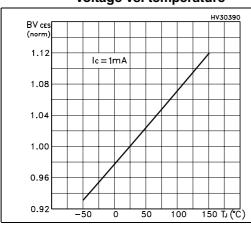


Figure 11. Switching losses vs. temperature

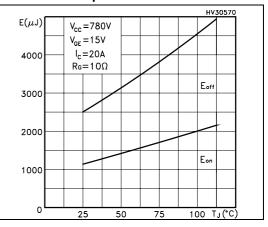
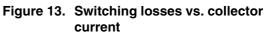
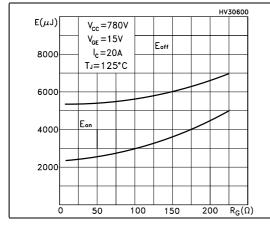
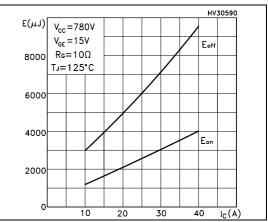


Figure 12. Switching losses vs. gate resistance



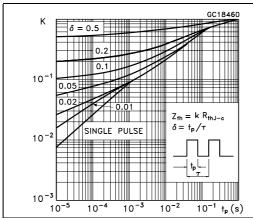




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Figure 14. Thermal Impedance

Figure 15. Turn-off SOA



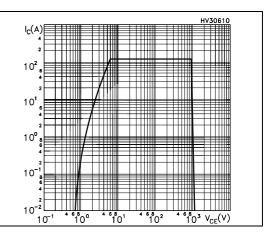
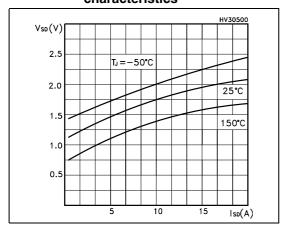


Figure 16. Emitter-collector diode characteristics



STGW30NC120HD Test circuit

## 3 Test circuit

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

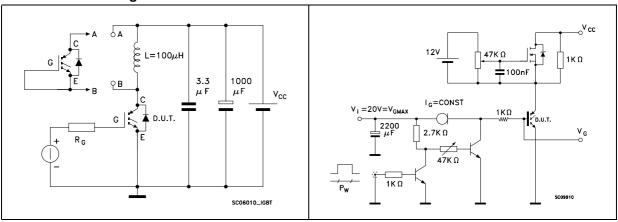
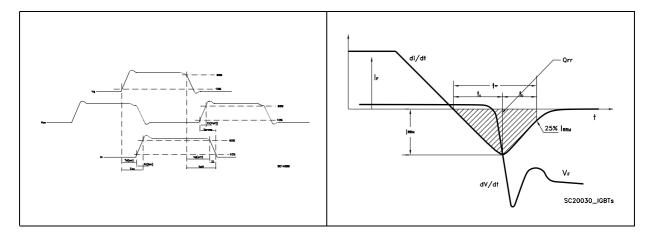


Figure 19. Switching waveform

Figure 20. Diode recovery time waveform

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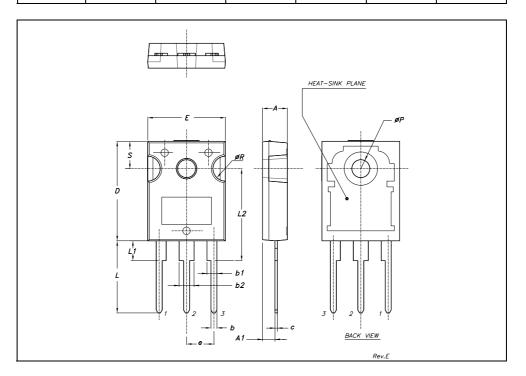


# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

#### **TO-247 MECHANICAL DATA**

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	



Revision history STGW30NC120HD

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
23-Nov-2005	1	First issue.
17-Mar-2006	2	Complete version
05-May-2006	3	Modified value on Table 2.: Absolute maximum ratings
30-May-2006	4	New values on Table 3: Thermal resistance
23-Jun-2006	5	Modified value on Table 4.: Static
07-Sep-2006	6	Modified T <sub>J</sub> temperature range to 150°C in Table 2.: Absolute maximum ratings
14-Nov-2006	7	Modified Figure 5. and Figure 9.
26-Jan-2007	8	Typing error on first page.
04-Oct-2007	9	Modified test conditions in Table 4.: Static

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